**PATENT ASSIGNMENT**

Electronic Version v1.1  
Stylesheet Version v1.1

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<th>SUBMISSION TYPE:</th>
<th>NEW ASSIGNMENT</th>
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<td>NATURE OF CONVEYANCE:</td>
<td>ASSIGNMENT</td>
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**CONVEYING PARTY DATA**

<table>
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<tr>
<th>Name</th>
<th>Execution Date</th>
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<tbody>
<tr>
<td>Che-Hua Hsu</td>
<td>01/27/2010</td>
</tr>
<tr>
<td>Zhi-Cheng Lee</td>
<td>01/27/2010</td>
</tr>
<tr>
<td>Cheng-Guo Chen</td>
<td>01/27/2010</td>
</tr>
<tr>
<td>Shao-Hua Hsu</td>
<td>01/27/2010</td>
</tr>
</tbody>
</table>

**RECEIVING PARTY DATA**

- Name: UNITED MICROELECTRONICS CORP.
- Street Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park
- City: Hsin-Chu City
- State/Country: TAIWAN

**PROPERTY NUMBERS Total: 1**

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**CORRESPONDENCE DATA**

- Fax Number: (703)997-4517  
*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*
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- Correspondent Name: WINSTON HSU
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**ATTORNEY DOCKET NUMBER:** NAUP1195USA

**NAME OF SUBMITTER:** Virginie Huang

Total Attachments: 4  
source=786031#page1.tif  
source=786031#page2.tif
ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar ($1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Che-Hua Hsu  Nationality: TW

Name: Zhi-Cheng Lee  Nationality: TW

Name: Cheng-Guo Chen  Nationality: TW

Name: Shao-Hua Hsu  Nationality: TW

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: UNITED MICROELECTRONICS CORP.

Address: No.3, Li-Hsin Road 2, Science-Based Industrial Park, Hsin-Chu City 300, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"METHOD OF FABRICATING EFUSE STRUCTURE, RESISTOR STRUCTURE AND TRANSISTOR STRUCTURE"

Which is found in:

(a) + U.S. patent application executed on even date
(b) ______ U.S. patent application executed on __________________________
(c) ______ U.S. application serial no. __________________________
(d) ______ patent no. __________________________ issued __________________________
and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this JAN 27 2010 (Date of signing).

(Type name of inventor)  Signature of INVENTOR
Che-Hua Hsu  Che-Hua Hsu
Zhi-Cheng Lee  
Cheng-Guo Chen  
Shao-Hua Hsu  

Assignment, Page 2 of 2

#NPO-P0002B-US1
DSC0-098001354
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(b) ______ U.S. patent application executed on _________________

(c) ______ U.S. application serial no. __________________________

(d) ______ patent no. ___________________ issued ________________
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(Type name of inventor)                                      Signature of INVENTOR
Che-Hua Hsu                                                   
Zhi-Cheng Lee                                                  
Cheng-Guo Chen                                                
Shao-Hua Hsu